

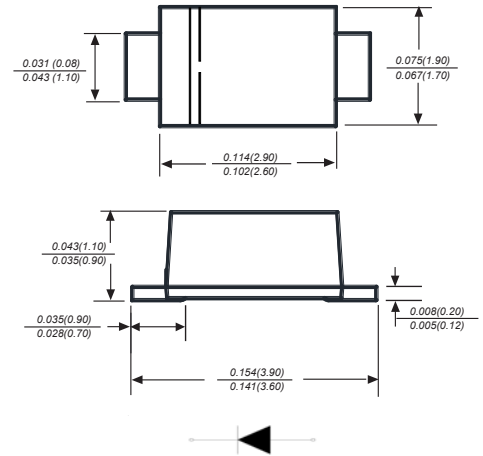
FEATURES

1. Glass passivated device
2. Ideal for surface mouted applications
3. Low reverse leakage
4. Metallurgically bonded construction
5. High temperature soldering guaranteed:
250°C/10 seconds,0.375"(9.5mm) lead
length, 5 lbs. (2.3kg) tension

MECHANICAL DATA

Case : JEDEC SOD-123FL Molded plastic body
Terminals : Solder plated, solderable per MIL-STD-750,
 Method 2026
Polarity : Polarity symbol marking on body
Mounting Position : Any
Weight : 0.0007 ounce, 0.02 grams

SOD-123FL



Dimensions in inches and (millimeters)

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase half-wave
 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	US2AW	US2BW	US2DW	US2EW	US2GW	US2JW	US2KW	US2MW	UNITS
Marking Code		2U1	2U2	2U3	2U4	2U5	2U6	2U7	2U8	
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	300	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	210	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	50	100	200	300	400	600	800	1000	V
Maximum average forward rectified current at TL=65℃	I _(AV)	2.0								A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	50								A
Maximum instantaneous forward voltage at 1.0A	V _F	1.0			1.30		1.70			V
Maximum DC reverse current at rated DC blocking voltage	I _R	5.0 100.0								μA
Maximum reverse recovery time (NOTE 1)	t _{rr}	50					75			ns
Typical junction capacitance (NOTE 2)	C _J	15.0								pF
Typical thermal resistance	R _{θJA}	90.0								℃/W
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150								℃

Note: 1. Measured with I_F=0.5A, I_R=1A, I_{rr}=0.25A.

Ratings And Characteristic Curves

Fig.1 Maximum Average Forward Current Rating

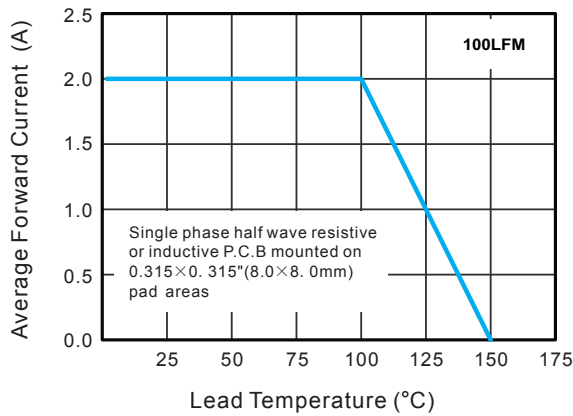


Fig.2 Typical Reverse Characteristics

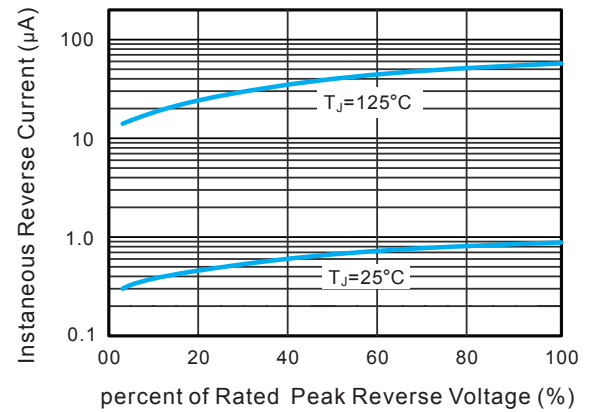


Fig.3 Typical Forward Characteristics

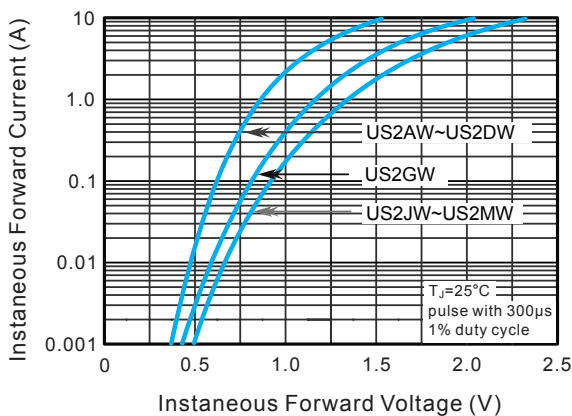


Fig.4 Typical Junction Capacitance

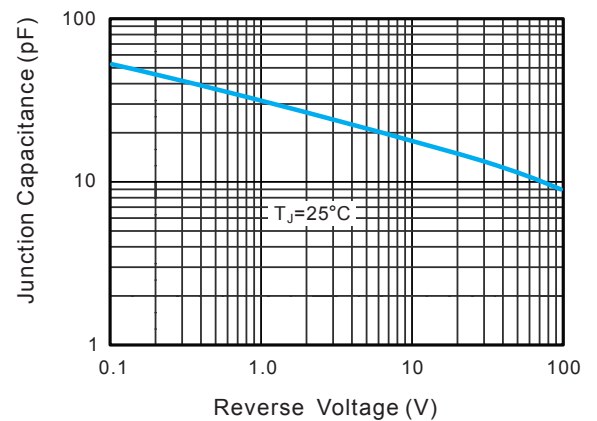


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

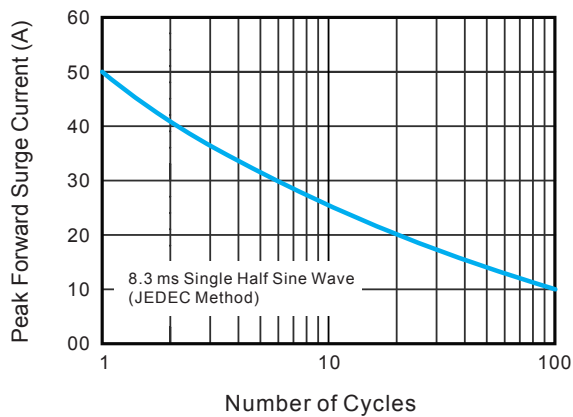
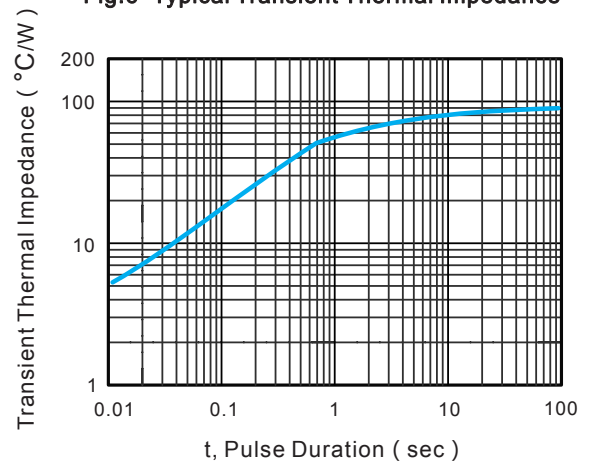
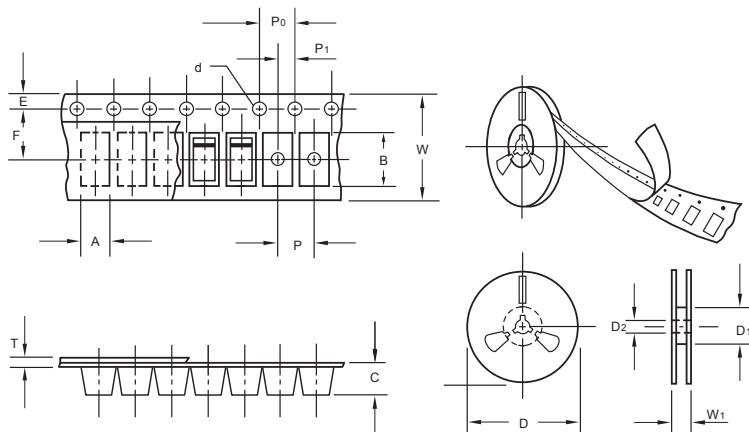


Fig.6- Typical Transient Thermal Impedance



Packing information

unit:mm



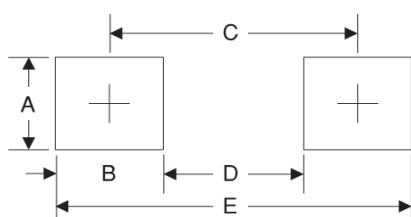
Item	Symbol	Tolerance	SOD-123FL
Carrier width	A	0.1	2.1
Carrier length	B	0.1	4.0
Carrier depth	C	0.1	1.60
Sprocket hole	d	0.05	1.55
7" Reel outside diameter	D	2.0	178.00
7" Reel inner diameter	D1	min	50.0
Feed hole diameter	D2	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	3.50
Punch hole pitch	P	0.1	4.00
Sprocket hole pitch	P0	0.1	4.00
Embossment center	P1	0.1	2.00
Overall tape thickness	T	0.1	0.25
Tape width	W	0.3	8.15
Reel width	W1	1.0	10.5

Note: Devices are packed in accordance with EIA standard RS-481-A and specifications listed above.

Reel packing

PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (m/m)	BOX (pcs)	INNER BOX (m/m)	REEL DIA, (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
SOD-123FL	7"	3,000	4.0	45,000	210*208*203	178	430*430*235	180,000	9.0

Suggested Pad Layout



Symbol	Unit (mm)	Unit (inch)
A	1.2	0.047
B	1.2	0.047
C	3.2	0.126
D	2	0.079
E	4.4	0.173